

EECS151/251A Spring 2023 Digital Design and Integrated Circuits

Instructors: John Wawrzynek

Lecture 22 - Energy

The Watt: Unit of power. A rate of energy (J/s). A gas pump hose delivers 6 MW. The Joule: Unit of energy. A 1 Gallon gas container holds 130 MJ of energy.

120 KW: The power delivered by a Tesla Supercharger. Tesla Model S has a 306 MJ battery (good for 265 miles).

1 J = 1 W * s 1 W = 1 J/s.

Chevy Bolt battery capacity: 66 KWhr = 237 MJ (good for 259 miles).



Energy and Power

Energy is the ability to do work (W). Power is rate of expending energy. Energy Efficiency: energy per operation

$$P = \frac{dW}{dt}$$

Handheld and portable (battery operated):
Energy Efficiency - limits battery life
Power - limited by heat



□ Infrastructure and servers (connected to power grid):

- Energy Efficiency dictates operation cost
- Power heat removal contributes to TCO

Remember: P = IV



Sad fact: Computers turn electrical energy into heat. Computation is a byproduct.

Energy and Performance

Air or water carries heat away, or chip melts.

The Joule: Unit of energy. Can also be expressed as Watt-Seconds. Burning 1 Watt for 100 seconds uses 100 Watt-Seconds of energy.

1A

1V

This is how electric tea pots work ...

1 Joule heats 1 gram of water 0.24 degree C

> 1 Joule of Heat Energy per Second

> > The Watt: Unit of power. The rate at which energy dissipated in the resistor.

1 Ohm Resistor

Watt

20 W rating: Maximum power the package is able to transfer to the air. Exceed rating and resistor burns.

Old example: Cooling an iPod nano ...



Like resistor on last slide, iPod relies on passive transfer of heat from case to the air.

Why? Users don't want fans in their pocket ...

To stay "cool to the touch" via passive cooling, power budget of 5 W.

If iPod nano used 5W all the time, its battery would last 15 minutes ...

Powering an iPod nano (2005 edition)



1.2 W-hour battery: Can supply 1.2 watts of power for 1 hour.

1.2 W-hr / 5 W \approx 15 minutes.

More W-hours require bigger battery and thus bigger "form factor" -it wouldn't be "nano" anymore :-).

Real specs for iPod nano : 14 hours for music, 4 hours for slide shows.

85 mW for music.300 mW for slides.

2015 **Apple** Watch



3.8 V, <u>0.78 Whr</u> lithium-ion battery on 38mm model. Apple claims the 205 mAh battery should provide up to 18 hours of use (which translates to 6.5 hours of audio playback, 3 hours of talk time, or 72 hours of Power Reserve mode.)





2.1 Wh battery – 2.7x as much energy as Apple watch.

Battery life very usage dependent.

640 x 360 Liquid Crystal on Silicon (LCoS) prism projector.

1.76 ounces -4X the weight ofiPod Shuffle

ма

Logic Board



4.7 inch iPhone6: 1,810mAh battery @3.8V = 6.88 Wh



iPhone 5s: 1570mAh @3.8V = 6 Wh

- The front side of the logic board:
 - Apple A8 APL1011 SoC + SK Hynix RAM as denoted by the markings H9CKNNN8KTMRWR-NTH (we presume it is 1 GB LPDDR3 RAM, the same as in the iPhone 6 Plus)
 - Qualcomm MDM9625M LTE Modem
 - Skyworks 77802-23 Low Band LTE PAD
 - Avago A8020 High Band PAD
 - Avago A8010 Ultra High Band PA + FBARs
 - SkyWorks 77803-20 Mid Band LTE PAD
 - InvenSense MP67B 6-axis Gyroscope and Accelerometer Combo



The A8 is manufactured on a 20 nm process by TSMC. It contains 2 billion transistors. Its physical size is 89 mm². It has 1 GB of LPDDR3 RAM included in the package. It is dual core, and has a frequency of 1.38 GHz.

Iphone 12:

https://unitedlex.com/insights/apple-iphone-12-pro-max-teardown-report

iPho	ne Model	Battery Capacity	14.13 Wh @ 3.8V (Pro Max)
iPhone	e 12 Mini	2,227 mAh	
iPhone	e 12	2,815 mAh	
iPhone	e 12 Pro	2,815 mAh	
iPhone	e 12 Pro Max	3,687 mAh	
iPhone	e 11	3,110 mAh	
iPhone	e 11 Pro	3,046 mAh	
iPhone	e 11 Pro Max	3,969 mAh	Richargadia Lindhetiry Atland
Accessory NFC Ante	Vireless Charging Coil		Image: Control of the control of th



Notebooks ... as designed in 2006 ...

2006 Apple MacBook -- 5.2 lbs



12.8 in

- Performance: Must be "close enough" to desktop performance ... most people no longer used a desktop (even in 2006).
- **Size and Weight**. Ideal: paper notebook.
- Heat: No longer "laptops" -- top may get "warm", bottom "hot". Quiet fans OK.

Battery: Set by size and weight limits ...

46x more energy than iPod

46x more energy than iPod nano battery. And iPod lets you listen to music for 14 hours!

Almost full 1 inch depth. Width and height set by available space, weight.

At 1 GHz, CPU consumes 13 Watts. "Energy saver" option uses this mode ...

Battery rating: 55 W-hour.

At 2.3 GHz, Intel Core Puo CPU consumes 31 W running a heavy load - under 2 hours battery life! And, just for CPU!

50Wh is 180,000 Joules!





MacBook Air ... design the laptop like an iPod/iPhone



Mainboard: fills about 25% of the laptop



35 W-h battery: 63% of 2006 MacBook's 55 W-h

MacBook Air: Full <u>PC</u>

Thunderbolt I/O

 \bigcirc

Platform Controller \ Hub

Core i5 CPU/GPU

................







Servers: Total Cost of Ownership (TCO)



Reliability: running computers hot makes them fail more often. Machine rooms are expensive. Removing heat dictates how many servers to put in a machine room.

Electric bill adds up! Powering the servers + powering the air conditioners is a big part of TCO. Computations per W-h doubles every 1.6 years, going back to the first computer.

(Jonathan Koomey, Stanford).



CMOS Circuits and Energy

Switching Energy: Fundamental Physics





How can we (1) Reduce # of clock transitions. But we have work to do ... limit (2) Reduce Vdd. But lowering Vdd limits the clock speed ... switching (3) Fewer circuits. But more transistors can do more work. energy? (4) Reduce C per node. One reason why we scale processes.

Chip-Level "Dynamic" Power



Additional Dynamic Power - "short circuit current"



 $V_{in} = V_{dd} - V_t$ $V_{dd} - V_t$ $I_{peak} t$ $I_{sc} = V_{dd} - V_t$

When gate switches, brief period when both pullup network and pulldown network could be on.

Worse when input is changing slowly compared to the output.

Another Factor: Leakage Currents

Logic gate isn't switching, it burns power.

Isub: Even when this nFet is off, it passes an loff leakage current.

We can engineer any loff we like, but a lower loff also rults in a lower lon, and thus r maximum clock speed.

s 17.

Intel's 2006 processor designs, leakage vs switching power

> A lot of work was done to get a ratio this good ... 50/50 is common.

Engineering "On" Current at 25 nm ...



Plot on a "Log" Scale to See "Off" Current



Customize processes for product types ...



From: "Facing the Hot Chips Challenge Again", Bill Holt, Intel, presented at Hot Chips 17, 2005.

- Vt is controlled by channel doping.
- Modern IC processes have 2 or 3 different Vt values available.
- Standard cell libraries offer low Vt and high Vt versions of cells so that the tools can optimize on a per instance basis.
- (If high performance not needed then use high Vt to reduce leakage).



Transistor channel is a raised fin. Gate controls channel from sides and top. Channel depth is fin width. 12-15nm for L=22nm.







Dynamic versus Leakage Power



Figure 1: The reduction of feature sizes from 45 to 7nm may induce drastic gains in power consumption and leakage power [Xie2015]

Xie, Q. (2015). Performance Comparisons between 7-nm FinFET and Conventional Bulk CMOS Standard Cell Libraries. IEEE Transactions on Circuits and Systems II: Express Briefs, 62(8), 761-765.

Total Power = $P_{switching}$ + $P_{short-circuit}$ + $P_{leakage}$







Some low-power design techniques

- **H** Parallelism and pipelining
- **H** Power-down idle transistors
- Slow down non-critical paths
- **H** Thermal management

Design Technique #1

Trading Hardware for Power

via Parallelism and Pipelining ...



THIS MAGIC TRICK BROUGHT TO YOU BY CORY HALL ...

Chandrakasan & Brodersen (UCB, 1992)

Architecture	Power (normalized)
Simple	1
Parallel	0.36
Pipelined	0.39
Pipelined-Parallel	0.2

Architecture	Area (normalized)				
Simple	1				
Parallel	3.4				
Pipelined	1.3				
Pipelined-Parallel	3.7				

Architecture	Voltage
Simple	5V
Parallel	2.9V
Pipelined	2.9V
Pipelined-Parallel	2.0











Pipelined

Minimizing Power Consumption in CMOS Circuits Anantha P. Chandrakasan Robert W. Brodersen

Example: Intel Graphics Pipeline IP



A 2.05 GVertices/s 151 mW Lighting Accelerator for 3D Graphics Vertex and Pixel Shading in 32 nm CMOS

Farhana Sheikh, Member, IEEE, Sanu K. Mathew, Member, IEEE, Mark A. Anders, Member, IEEE, Himanshu Kaul, Member, IEEE, Steven K. Hsu, Member, IEEE, Amit Agarwal, Member, IEEE, Ram K. Krishnamurthy, Fellow, IEEE, and Shekhar Borkar, Fellow, IEEE

Clock Rate and Power vs Voltage



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Voltage Scaling

 $P_{sw} = 1/2 \ \alpha \ C \ V_{dd}^{-2} \ F$

Reducing F, reduces power, but our computation now takes longer, and total energy does not change. Reducing both F and Vdd, reduces power but also improves energy efficiency (total energy for computation is less).

Parallelism gives us a way to make up for lower performance from voltage scaling.

Multiple Cores for Low Power

Trade hardware for power, on a large scale ...

Cell: The PS3 chip















Cell (PS3 Chip): 1 CPU + 8 "SPUs"



A "Schmoo" plot for a Cell SPU ...



Vdd (Volt)

Clock speed alone doesn't help E/op ...

But, lowering clock frequency while keeping voltage constant spreads the same amount of work over a longer time, so chip stays cooler ...

$$\mathbf{E}_{0\to 1} = \frac{1}{2} \mathbf{C} \mathbf{V}_{dd}^2 \mathbf{E}_{1\to 0} = \frac{1}{2} \mathbf{C} \mathbf{V}_{dd}^2$$

								_								*	
1.3	48C 4W	49 C 4 W	50C 5W	50C 6W	51C 6W	52C 7W	53C 7W	54C 7W	55C 8W	56C 8W	57C 9W	58C 9W	59C 10W	60C 10W	61C 10W	63C 11W	61C
1.2	39C 2W	39 C 3 W	40C 3W	41C 4W	42C 4W	42C 4W	43C 5W	44C 5W	45C 5W	45C 5W	46C 6W	47C 6W	47C 7 W	48C	49C		
1.1	32 C 2 W	33C 2W	33C 3W	35C 3W	35C 3W	36C 3W	36C 4W	37C 4W	37C 4W	38C 4W	38C 4W	39C	39C				
1	28C 2W	28C 2W	29C 2W	29C 2W	30C 2W	30C 3W	30C 3W	31C 3W	31C 3W	31C 3W	32C						
0.9	25C 1W	26C 1W	26C 1W	26C 2W	27C 2W	27C 2W	27C								Faile	a //	
	2	2.2	2,4	2.6	2.8	ω	3.2	ω 4	3.6		4	4.2	4. 4	.4 6	.4 8	տ	5 2
								F	req (GI	Hz)							

Vdd (Volt)

Scaling V and f does lower energy/op

1 W to get 2.2 GHz performance. 26 C die temp.

7W to reliably get 4.4 GHz performance. 47C die temp.

If a program that needs a 4.4 Ghz CPU can be recoded to use two 2.2 Ghz CPUs ... big win.

1.3	48C 4W	49 43	5 U	50C 5W	50C 6W	51C 6W	52C 7W	53C 7W	54C 7W	55C 8W	56C 8W	57C 9W	58C 9W	59C 10W	60C 10W	61C 10W	63C 11W	61C
1.2	39C 2W	39 31	C V	40C 3W	41C 4W	42C 4W	42C 4W	43C 5W	44C 5W	45C 5W	45C 5W	46C 6W	47C 6W	47C 7 W	48C	49C		
1.1	32 C 2 W	33 2 V	C V	33C 3W	35C 3W	35C 3W	36C 3W	36C 4W	37C 4W	37C 4W	38C 4W	38C 4W	39C	39C				
1	28C 2W	28 2 V	C V	29C 2W	29C 2W	30C 2W	30C 3W	30C 3W	31C 3W	31C 3W	31C 3W	32C						
0.9	25C 1W	26 1V	C V	26C 1W	26C 2W	27C 2W	27C 2W	27C								Faile	a //	
·	2		22	2,4	2.6	2.8	ω	3.2	.3 4	3.6	.3 .8	4	4.2	.4 4	4.6	4.8	տ	52
		Free (GHz)																

Vdd (Volt)

Dynamic Voltage/Frequency Scaling (DVFS)



Intel power states

- BIO/OS software can adjust frequency to reduce heat and/or improve power efficiency with high performance not needed.
- Adjusting both voltage and frequency helps improve energy efficiency and allows higher frequency for a given power level.

Design Technique #2 (of 5)

Powering down idle circuits

Add "sleep" transistors to logic ...



Example: Floating point unit logic.

When running fixed-point instructions, put logic "to sleep".

+++ When "asleep", leakage power is dramatically reduced.

---- Presence of sleep transistors slows down the clock rate when the logic block is in use.

Intel example: Sleeping cache blocks



A tiny current supplied in "sleep" maintains SRAM state.

From: "Facing the Hot Chips Challenge Again", Bill Holt, Intel, presented at Hot Chips 17, 2005.

Intel Medfield



Intel Medfield

Switches 45 power "islands."

Fine-grained control of leakage power, to track user activity.

"Race to idle" strategy -finish tasks quickly, to get to power down.



Playing a game ...



Watching a video ...





Looking at phone screen, not doing anything ...



Phone in your pocket, waiting for a call ...



Design Technique #3 (of 5)

Slow down "slack paths"

Fact: Most logic on a chip is "too fast"



From "The circuit and physical design of the POWER4 microprocessor", IBM J Res and Dev, 46:1, Jan 2002, J.D. Warnock et al.

Use several supply voltages on a chip ...



Why use multi-Vdd? We can reduce dynamic power by using low-power Vdd for logic off the critical path.

In practice, instead of multi-Vdd design ... In a multi-Vt process, we can reduce leakage power on the off critical path logic by using high-Vth transistors. Design Technique #5 (of 5)

Thermal Management

Keep chip cool to minimize leakage power



Optimizing Designs for Power Consumption through Changes to the FPGA Environment

XILINX[®]

WP285 (v1.0) February 14, 2008

Intel realtime temp monitoring

